



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Examiner: Henry S. Hu

Satoru Amou, et al.

Application No.: 10/649,950 Art Unit: 1713

Filed: August 28, 2003 Allowed: March 23, 2005

For: LOW DIELECTRIC LOSS TANGENT

RESIN COMPOSITION, CURABLE FILM AND CURED PRODUCT, ELECTRICAL PART USING THE

SAME AND METHOD FOR PRODUCTION THEREOF

COMMENTS ON EXAMINER'S STATEMENT OF REASONS FOR ALLOWANCE

Commissioner for Patents

MS: <u>Issue Fee</u> P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

The Examiner's Statement of Reasons for Allowance, page 3, attached to the Notice of Allowability dated March 23, 2005, incorrectly suggests that "Claims 12 and 13 relate to making an electrical part having an insulator layer containing the cured product of Claim 10." Please note that claim 10 does not recite the "filler" of claim 12. Nor does claim 12 recite the "film-forming ability" that is recited in claim 10.

On page 4, the Examiner's Statement incorrectly suggests that "Claim 14 relates to a cured product of Claim 10 with a high polymer having a weight average

molecular weight of not less than 5,000 and a filler." Please note that claim 14 does not recite the "film-forming ability" of claim 10. The scope of the claims should be determined according to their actual language.

Further, on page 4, the Examiner's Statement incorrectly suggests that the word "contain" is "closed language." Please note that the word "contain" is openended, and is synonymous with "comprising." M.P.E.P. § 2111.03.

Concerning page 7 of the Examiner's Statement, please note that the application does not contain claim 1. Only claims 9-14 are pending.

For at least these reasons, Applicants only agree that the prior art of record does not teach or suggest the claimed invention.

Dated: June 23, 2005

Respectfully submitted,

Mark J. Thronson

Registration No.: 33,082

DICKSTEIN SHAPIRO MORIN &

OSHINSKY LLP

2101 L Street NW

Washington, DC 20037-1526

(202) 785-9700

Attorney for Applicants